DATA SHEET

Part No.	
Package Code No.	

AN78L06M

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AN78L06M 3-pin positive output voltage regulator (100 mA type)

Overview

The AN78LxxM series are 3-pin, fixed positive output type monolithic voltage regulators. Stabilized fixed output voltage is obtained from unstable DC input voltage without using any external components. 12 types of fixed output voltage are available; 4 V, 5 V, 6 V, 7 V, 8 V, 9 V, 10 V, 12 V, 15 V, 18 V, 20 V and 24 V. They can be used widely in power circuits with current capacity of up to 100 mA. The AN78L06M is the 6 V output voltage type in these series.

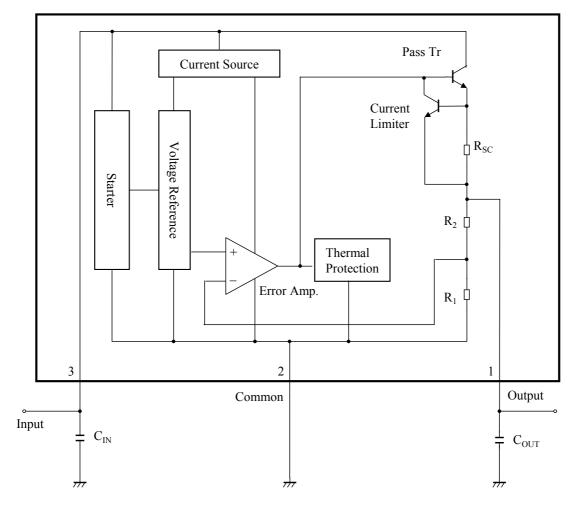
Features

- No external components
- Output voltage: 6 V
- Built-in overcurrent limit circuit
- Built-in thermal overload protection circuit

Applications

- 3-pin positive output voltage regulator (100 mA type)
- Package
 - 3-pin plastic single inline package with heat sink (SIP type)
- Type
 - Silicon monolithic bipolar IC

Block Diagram



C _{IN}	: 0.33 µF
	: 0.1 µF
R_1	: 4 kΩ
Ra	: 2 kΩ

AN78L06M

Pin Descriptions

Pin No.	Pin name	Туре	Description
1	Output	Output	Regulated power output
2	Common	GND	Ground
3	Input	Input	Input supplies power to the internal circuitry

Absolute Maximum Ratings

A No.	Parameter	Symbol	Rating	Unit	Note
1	Input voltage	V _{IN}	35	V	*1
2	Supply current	I _{CC}	270	mA	*2
3	Power dissipation	P _D	342	mW	*3
4	Operating ambient temperature	T _{opr}	-30 to + 80	°C	*4
5	Storage temperature	T _{stg}	-55 to +150	°C	*4

Note) *1: The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

*2: Since current limiting circuit is built in, current value never exceeds the limit.

*3: The power dissipation shown is the value at $T_a = 80^{\circ}C$.

When using this IC, refer to the $\bullet P_D - T_a$ diagram in the \blacksquare Technical Data and use under the condition not exceeding the allowable value. When T_i exceeds 150°C, the internal circuit cuts off the output.

*4: Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for $T_a = 25^{\circ}C$.

Operating supply voltage range

Parameter	Symbol	Range	Unit	Note
Supply voltage range	V _{CC}	8.5 to 21	V	_

Note) The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

Electrical Characteristics

Note) Unless otherwise specified, $T_a = 25^{\circ}C \pm 2^{\circ}C$, $V_{IN} = 11$ V, $I_{OUT} = 40$ mA, $C_{IN} = 0.33$ µF and $C_{OUT} = 0.1$ µF, $T_j = 0^{\circ}C$ to $125^{\circ}C$

В	Deremeter	Sumbol	l Conditions		Limits			Linit	Nata
No.	Parameter	Symbol	Conditions	Min	Тур	Max	Unit	Note	
1	Output voltage	V _{OUT}	$T_j = 25^{\circ}C$	5.76	6.0	6.24	V	*1	
2	Output voltage tolerance	V _{OUT}	$V_{IN} = 8.5 V \text{ to } 21 V,$ $I_{OUT} = 1 \text{ mA to } 70 \text{ mA}$	5.7		6.3	V	*1	
2	3 Line regulation REG _I	DEC	$V_{IN} = 8.5 \text{ V to } 21 \text{ V}, T_j = 25^{\circ}\text{C}$		60	155	ταV	*1	
3		KEGIN	$V_{IN} = 9 V$ to 21 V, $T_j = 25^{\circ}C$		50	105	mV	.1	
4	Load regulation	REGL	$I_{OUT} = 1 \text{ mA to } 100 \text{ mA}, T_j = 25^{\circ}\text{C}$		12	65	mV	*1	
4			$I_{OUT} = 1 \text{ mA to } 40 \text{ mA}, T_j = 25^{\circ}\text{C}$		5.5	35			
5	Bias current	I _{Bias}	$T_j = 25^{\circ}C$		2.0	3.0	mA	*1	
6	Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{IN} = 9 V$ to 21 V, $T_j = 25^{\circ}C$			1.0	mA	*1	
7	Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_{OUT} = 1$ mA to 40 mA, $T_j = 25^{\circ}C$			0.1	mA	*1	
8	Ripple rejection ratio	RR	$V_{IN} = 9 V$ to 19 V, $I_{OUT} = 40 \text{ mA}, f = 120 \text{ Hz}$	46	56	_	dB	—	

Note) *1: The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Electrical Characteristics (Reference values for design)

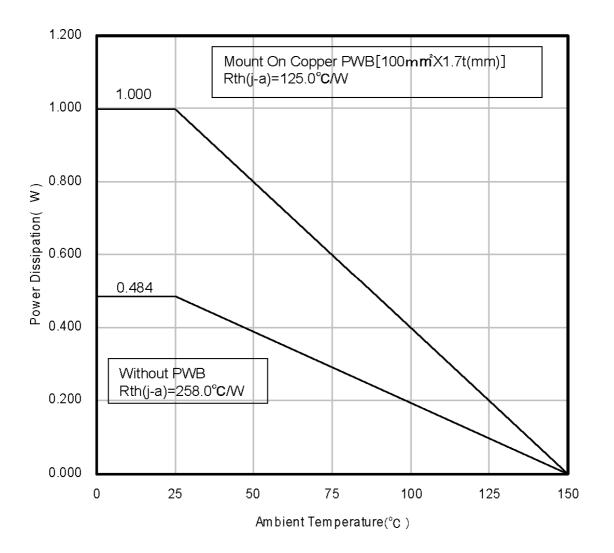
Note) Unless otherwise specified, $T_a = 25^{\circ}C \pm 2^{\circ}C$, $V_{IN} = 11$ V, $I_{OUT} = 40$ mA, $C_{IN} = 0.33 \mu$ F and $C_{OUT} = 0.1 \mu$ F, $T_j = 0^{\circ}C$ to $125^{\circ}C$. The characteristics listed below are reference values for design of the IC and are not guaranteed by inspection. If a problem does occur related to these characteristics, Panasonic will respond in good faith to user concerns.

B No.	Parameter	Symbol	Conditions Reference	rence va	alues	Unit	Note	
	Farallielei			Min	Тур	Max	Unit	NOLE
1	Output noise voltage	Vno	f = 10 Hz to 100 kHz		50		μV	—
2	Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		1.7		V	*1
3	Output short-circuit current	I _{O(Short)}	$T_j = 25^{\circ}C$		140	_	mA	*1
4	Output voltage temperature coefficient	$\frac{\Delta V_{OUT}}{T_a}$	$I_{OUT} = 5 \text{ mA},$ $T_j = 0^{\circ}C \text{ to } 125^{\circ}C$		- 0.7		mV/°C	

Note) *1: The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Technical Data

• $P_D - T_a$ diagram



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